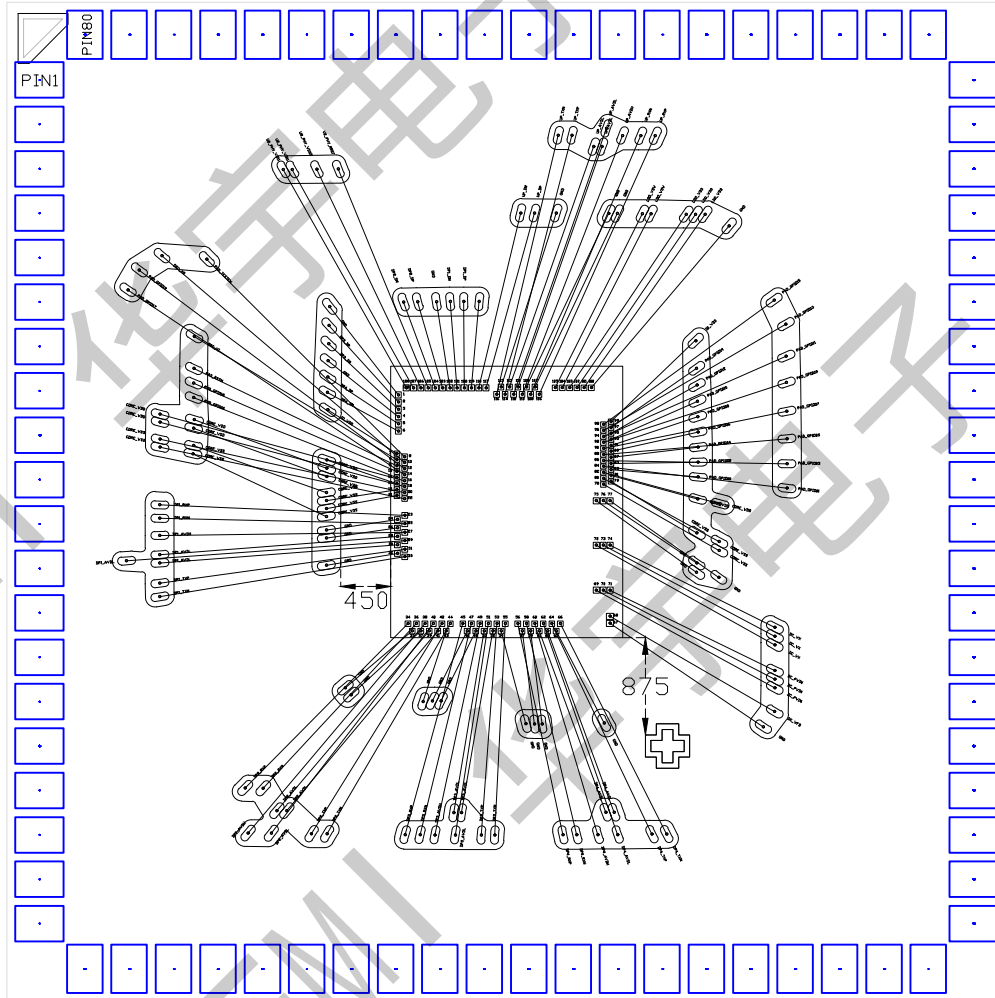
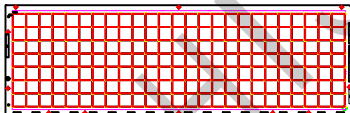
 池州华宇电子科技股份有限公司 CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD 焊线图纸 Bonding Diagram				客户代码 Customer No.	线图号 Drawing No.	封装外型 PKG Type	LGA80L(9.0×9.0×1.31-P0.40)
焊线种类 Wire Type	焊线直径(μm) Wire Diameter	焊线根数 NO. of wire	焊线总长(μm) Total wire length	最长线长(μm) Longest wire length	最短线长(μm) Shortest wire length	塑封料型号(绿色环保) Compound Type (Green)	基板编码 Substrate No.
镀钎铜丝 PdCu	18				646	首选(Preferred): G760L TypeA 备选(Optional):	
剪刀型号 Capillary Type			客户图号 Customer drawing NO.				



框架传送方向(装片): L/F Direction (D/A): 	实物图: Chip photo:	特殊说明 Special Instructions: DB注意: 1.装片位置公差为±30um; 2.控制溢胶,为WB预留焊线位置。 WB注意: 1.外圈PAD为第一圈PAD 2.第二圈PAD优先考虑高线弧避免与外圈PAD焊线相交。
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说明 Instructions	粘片胶类型 epoxy type	芯片名称 Die name	芯片尺寸 Die Size	最小焊盘尺寸 Min BPO (μm²)	最小焊盘间距 Min BPP(μm)	铝垫厚度(μm) Pad Thickness	焊盘下是否有电路 Circuit under Pad	划片道宽度 Street line (μm)	晶圆尺寸 Wafer Size	是否是 Low-K If low-k?	减薄厚度 (μm) Wafer Thickness
A芯: DIE A	导电胶 (conductivity) S220		2028.68*2384.27(μm²) 79.86*93.86(mil²)	49.5*47.3	65	2.8	是/Yes	60	12	是/Yes 40nm	160 (客户需求)
B芯: DIE B											
C芯: DIE C											
D芯: DIE D											
E芯: DIE E											

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拟制 Prepared by	审核 Checked by	批准 Approved by

*温馨提示: 图纸为产品下线生产的唯一依据, 请您认真确认, 我司依据您回签后的图纸生产, 如图纸错误会产生不可估量损失, 谢谢!
 *warm tips: the drawing is the only basis for the production of the product. Please confirm it carefully. Our company will produce the drawings according to the drawings you have signed back, such as drawing mistakes, which will produce incalculable loss. Thank you



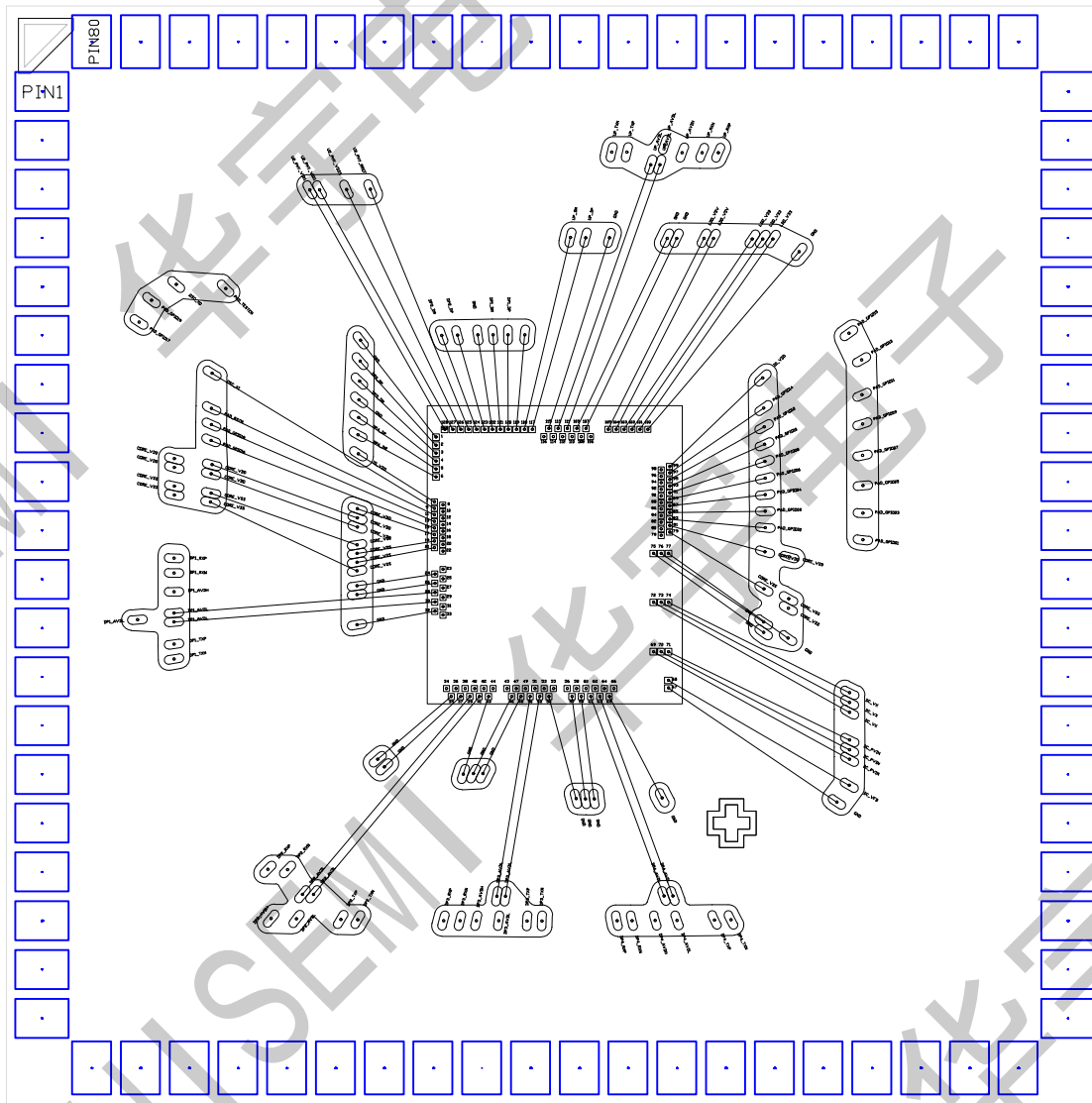
池州华宇电子科技股份有限公司

CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD

焊线图纸 Bonding Diagram

客户代码 Customer No.		线图号 Drawing No.	
产品名称 Product Type		封装外型 PKG Type	LG A80L(9.0×9.0×1.31-P0.40)
焊线种类 Wire Type	焊线直径(μm) Wire Diameter	焊线根数 NO. of wire	焊线总长(μm) Total wire length
镀钎铜丝 PdCu	18		
		最长线长(μm) Longest wire length	最短线长(μm) Shortest wire length
		2255	646
		塑料封型号(绿色环保) Compound Type (Green)	
		基板编码 Substrate No.	
剪刀型号 Capillary Type		客户图号 Customer drawing NO.	

第一圈PAD打线示意图



实物图：
Chip photo:

特殊说明 Special Instructions :

DB注意：
1. 装片位置公差为±30μm；
2. 控制溢胶，为WB预留焊线位置。

WB注意：
1. 外圈PAD为第一圈PAD
2. 第二圈PAD优先考虑高线弧避免与外圈PAD焊线相交。

制图日期 Create Date		生效日期 Effective Date		客户确认签字/盖章： Customer Signature
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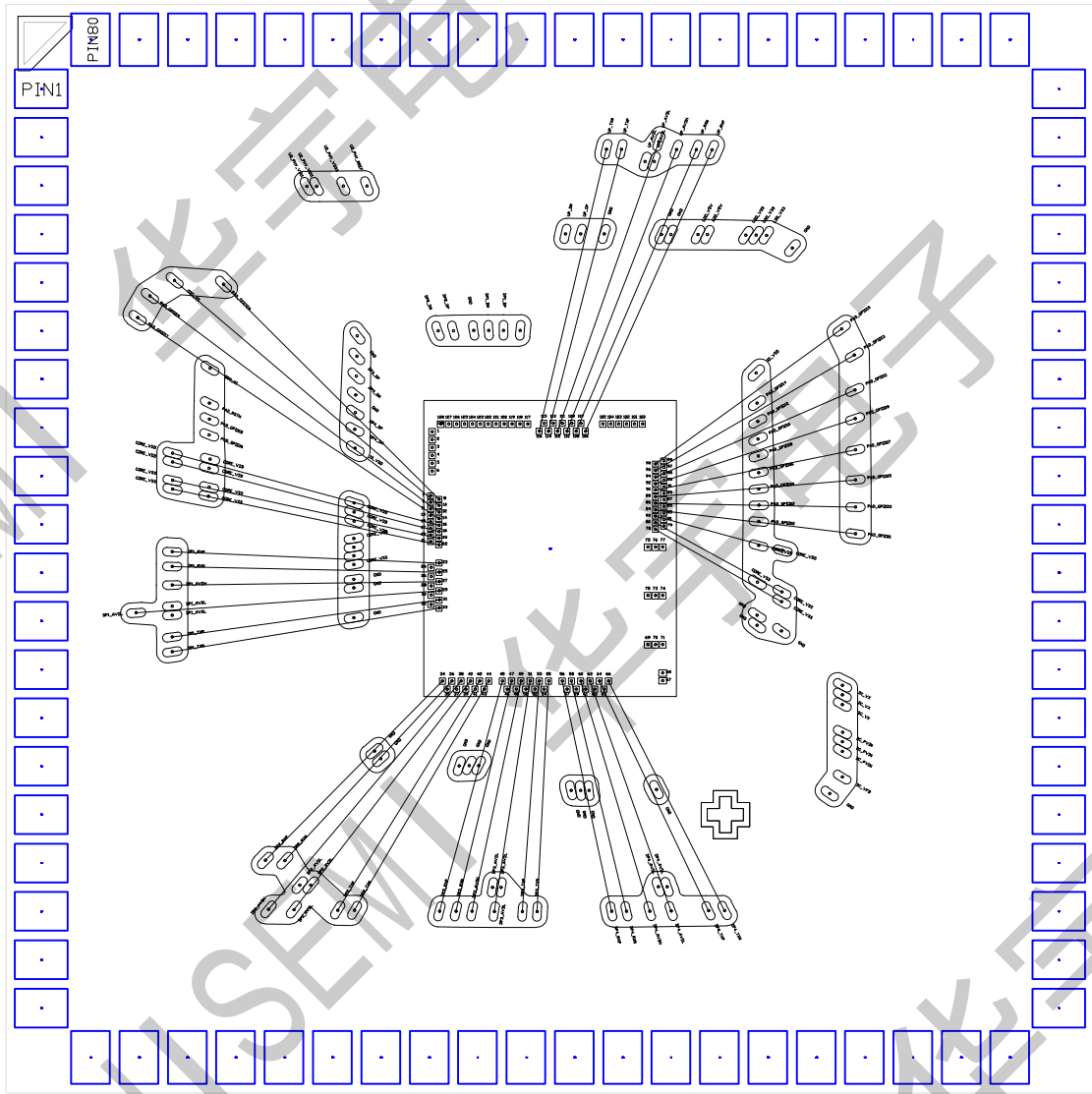
2 / 4



池州华宇电子科技股份有限公司
CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD
焊线图纸 Bonding Diagram

客户代码 Customer No.		线图号 Drawing No.	
产品名称 Product Type		封装外型 PKG Type	LG A80L(9.0×9.0×1.31-P0.40)
焊线种类 Wire Type	焊线直径(μm) Wire Diameter	焊线根数 NO. of wire	焊线总长(μm) Total wire length
镀钎铜丝 PdCu	18		2995
			1203
剪刀型号 Capillary Type		客户图号 Customer drawing NO.	
		塑封料型号(绿色环保) Compound Type (Green)	
		首选(Preferred): G760L TypeA 备选(Optional):	
		基板编码 Substrate No.	

第二圈PAD打线示意图



实物图：
Chip photo:

特殊说明 Special Instructions :

- DB注意:**
 1. 装片位置公差为±30μm;
 2. 控制溢胶, 为WB预留焊线位置。

- WB注意:**
 1. 外圈PAD为第一圈PAD
 2. 第二圈PAD优先考虑高线弧避免与外圈PAD焊线相交。

制图日期 Create Date		生效日期 Effective Date		客户确认签字/盖章: Customer Signature
拟制 Prepared by		审核 Checked by		批准 Approved by

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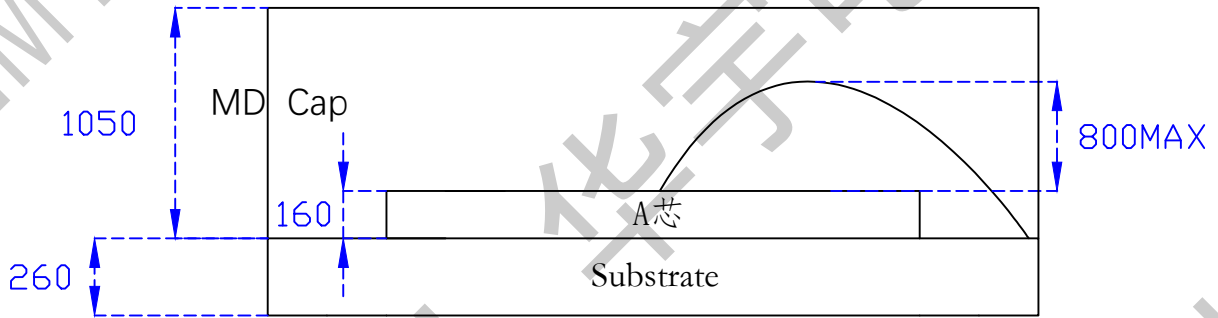


池州华宇电子科技股份有限公司

CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD

焊线图纸 Bonding Diagram

客户代码 Customer No.				线图号 Drawing No.		封装外型 PKG Type		LGA80L(9.0×9.0×1.31-P0.40)
产品名称 Product Type				最长线长(μm) Longest wire length		最短线长(μm) Shortest wire length		基板编码 Substrate No.
焊线种类 Wire Type	焊线直径(μm) Wire Diameter	焊线根数 NO. of wire	焊线总长(μm) Total wire length	2995	646	塑封料型号(绿色环保) Compound Type (Green)		首选(Preferred): G760L TypeA 备选(Optional):
镀钎铜丝 PdCu	18							
剪刀型号 Capillary Type			客户图号 Customer drawing NO.					



制图日期 Create Date		生效日期 Effective Date		客户确认签字/盖章: Customer Signature	
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					页码 Page 4/4